



Molding Power Inductor

GMPC0512HP-Serise(G)-D

1. Features

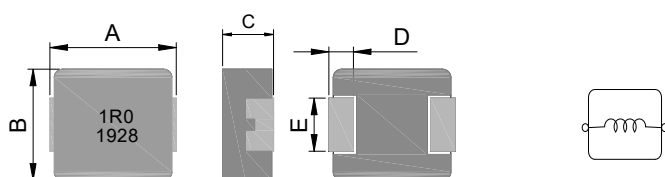
1. Carbonyl Powder.
2. Compact design.
3. High current, low DCR, high efficiency.
4. Very low acoustic noise and very low leakage flux noise.
5. High reliability.
6. 100% Lead(Pb)-Free and RoHS compliant
7. Operating temperature -40~+125℃(Including self - temperature rise)



2. Applications

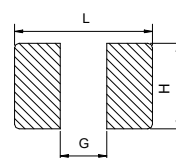
Note PC power system, incl. IMVP-6
DC/DC converter .

3. Dimensions



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
GMPC0512HP	5.7±0.3	5.2±0.2	1.0±0.2	1.1±0.3	2.5±0.3

Recommend PC Board Pattern



L(mm)	G(mm)	H(mm)
6.2	2.2	2.8

Note: 1. The above PCB layout reference only.
2. Recommend solder paste thickness at 0.12mm and above.

4. Part Numbering

GMPC 0512 HP - 1R0 MG - D
A B C D E F

A: Series

B: Dimension

C: Type

D: Inductance

E: Inductance Tolerance

F: Code

BxC

HP:H:Carbonyl Powder. P:PAD broaden.

1R0=1.0uH

M=±20%

Marking: Black.1R0 and 1928(19 YY, 28WW, follow production date).



5. Specification

Part Number	Inductance L0 (uH)±20%	I rms (A) Typ	I sat (A) Typ	DCR(mΩ) Typ.@25℃	DCR(mΩ) Max.@25℃
GMPC0512HP-R10YG-D	0.10±30%	14	14.5	4.3	5.2
GMPC0512HP-R15YG-D	0.15±30%	12	14.2	4.5	6.0
GMPC0512HP-R22YG-D	0.22±30%	10.7	14.0	5.5	6.7
GMPC0512HP-R22MG-D	0.22±20%	10.7	14.0	5.5	6.7
GMPC0512HP-R33MG-D	0.33	8.5	13.5	7.8	9.4
GMPC0512HP-R36MG-D	0.36	8.0	13	10	11.5
GMPC0512HP-R47MG-D	0.47	7.0	11	13.6	15.8
GMPC0512HP-R68MG-D	0.68	6.0	9.0	21.5	24.5
GMPC0512HP-1R0MG-D	1.00	5.0	6.0	26	30
GMPC0512HP-1R2MG-D	1.20	4.5	5.5	33	40
GMPC0512HP-1R5MG-D	1.50	4.0	5.0	38	44
GMPC0512HP-2R2MG-D	2.20	3.5	4.0	65	75
GMPC0512HP-3R3MG-D	3.30	3.0	3.8	75	86
GMPC0512HP-4R7MG-D	4.70	2.5	3.2	100	115
GMPC0512HP-5R6MG-D	5.60	2.4	3.2	175	201
GMPC0512HP-6R8MG-D	6.80	2.0	3.0	193	222
GMPC0512HP-8R2MG-D	8.20	1.7	2.8	327	378
GMPC0512HP-100MG-D	10.0	1.5	1.8	335	385
GMPC0512HP-150MG-D	15.0	1.3	1.6	410	470

Note:

1. Test frequency : Ls : 100KHz /1.0V.
2. All test data referenced to 25℃ ambient.
3. Testing Instrument(or equ) : L: HP4284A,CH11025,CH3302,CH1320,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER.
4. Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40℃
5. Saturation Current (Isat) will cause L0 to drop approximately30%.
6. The part temperature (ambient + temp rise) should not exceed 125℃under worst case operating conditions.Circuit design,component,PCB trace size and thickness,airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
7. Special inquiries besides the above common used types can be met on your requirement.



10. Typical Performance Curves

